

Title (en)

ELECTRIC CONTACT

Title (de)

ELEKTRISCHES KONTAKTELEMENT

Title (fr)

ÉLÉMENT DE CONTACT ÉLECTRIQUE

Publication

**EP 2900849 A1 20150805 (DE)**

Application

**EP 13756807 A 20130731**

Priority

- DE 102012109057 A 20120926
- DE 2013100280 W 20130731

Abstract (en)

[origin: WO2014048414A1] The invention relates to a method for producing an electrical contact element, wherein the contact element is formed substantially from a main body and said main body undergoes the following method steps in the sequence listed: a. degreasing of the surface, for example cold degreasing and/or hot degreasing and/or electrolytic degreasing, b. flushing to remove chemical residues which may be present, c. activation of the surface, d. deposition of a nickel layer, e. further flushing to remove chemical residues which may be present, f. deposition of a nickel alloy, g. further flushing to remove chemical residues which may be present, h. deposition of a gold layer or of a gold alloy.

IPC 8 full level

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CPC (source: CN EP US)

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Citation (search report)

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